

N-channel 900 V, 0.60 Ω typ., 8 A MDmesh™ K5 Power MOSFET in a TO-220 package

Datasheet - production data

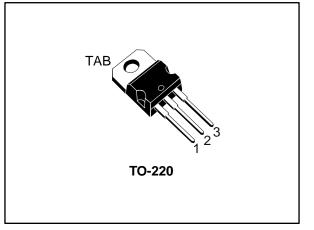
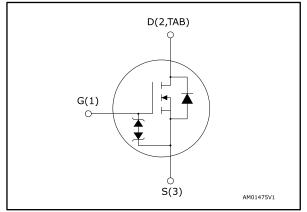


Figure 1: Internal schematic diagram



Features

Order code	VDS	R _{DS(on)} max.	ID
STP8N90K5	900 V	0.68 Ω	8 A

- Industry's lowest R_{DS(on)} x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh[™] K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STP8N90K5	8N90K5	TO-220	Tube

DocID030086 Rev 1

This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±30	V
ID ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	8	А
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	5	А
I _D ⁽²⁾	Drain current pulsed	32	А
Ртот	Total dissipation at $T_C = 25 \text{ °C}$	130	W
dv/dt ⁽³⁾	Peak diode recovery voltage slope	4.5	
dv/dt ⁽⁴⁾	MOSFET dv/dt ruggedness	50	V/ns
TJ	Operating junction temperature range	55 to 150	°C
T _{stg}	Storage temperature range	-55 to 150	

Notes:

⁽¹⁾Limited by maximum junction temperature.

 $^{(2)}\mbox{Pulse}$ width limited by safe operating area

 $^{(3)}I_{SD} \leq 8$ A, di/dt \leq 100 A/µs; V_Ds peak \leq V(BR)DSS

 $^{(4)}V_{DS} \le 720 \text{ V}$

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj} -case	Thermal resistance junction-case	0.96	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
Iar	Avalanche current, repetitive or not repetitive (pulse width limited by TJ max)	2.7	А
Eas	Single pulse avalanche energy (starting $T_J = 25 \text{ °C}$, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$)	250	mJ



2 Electrical characteristics

 $T_C = 25$ °C unless otherwise specified

Table 5: On/off-State							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
V _{(BR)DSS}	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	900			V	
IDSS	Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 900 V$			1	μA	
		$V_{GS} = 0 V, V_{DS} = 900 V,$ Tc = 125 °C ⁽¹⁾			50	μA	
I _{GSS}	Gate body leakage current	V_{DS} = 0 V, V_{GS} = ±20 V			±10	μA	
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 100 \ \mu A$	3	4	5	V	
R _{DS(on)}	Static drain-source on-resistance	V_{GS} = 10 V, I_D = 4 A		0.60	0.68	Ω	

Table 5: On/off-state

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	426	-	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, \text{ f} = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	-	41	-	pF
Crss	Reverse transfer capacitance	163 - 0 1	-	1.2	-	pF
Co(tr) ⁽¹⁾	Equivalent capacitance time related	V _{DS} = 0 to 720 V,	-	75	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	V _{GS} = 0 V	-	28	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz , I _D = 0 A	-	7	-	Ω
Qg	Total gate charge	$V_{DD} = 720 \text{ V}, \text{ I}_{D} = 8 \text{ A},$	-	11	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 10 V	-	3.5	-	nC
Q _{gd}	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	4.8	-	nC

Table 6: Dynamic

Notes:

 $^{(1)}$ Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when V_{DS} increases from 0 to 80% V_{DSS}

 $^{(2)}\mathsf{E}\mathsf{nergy}$ related is defined as a constant equivalent capacitance giving the same stored energy as Coss when V_Ds increases from 0 to 80% V_Dss



Electrical characteristics

	Table 7: Switching times							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
t _{d(on)}	Turn-on delay time	V _{DD} = 450 V, I _D = 4 A,	-	14.7	-	ns		
tr	Rise time	R_G = 4.7 Ω, V_{GS} = 10 V (see Figure 14: "Test circuit for	-	13.2	-	ns		
t _{d(off)}	Turn-off delay time	resistive load switching times"	-	36.4	-	ns		
tr	Fall time	and Figure 19: "Switching time waveform")	-	13.5	-	ns		

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		8	А
Isdm ⁽¹⁾	Source-drain current (pulsed)		-		32	А
Vsd ⁽²⁾	Forward on voltage	$I_{SD} = 8 \text{ A}, V_{GS} = 0 \text{ V}$	-		1.5	V
trr	Reverse recovery time	I _{SD} = 8 A, di/dt = 100 A/µs,	-	371		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 V$	-	4.27		μC
I _{RRM}	Reverse recovery current	(see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	23		A
trr	Reverse recovery time	I _{SD} = 8 A, di/dt = 100 A/µs,	-	582		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 ^{\circ}\text{C}$	-	5.73		μC
Irrm	Reverse recovery current	(see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	19.7		A

Notes:

⁽¹⁾Pulse width limited by safe operating area

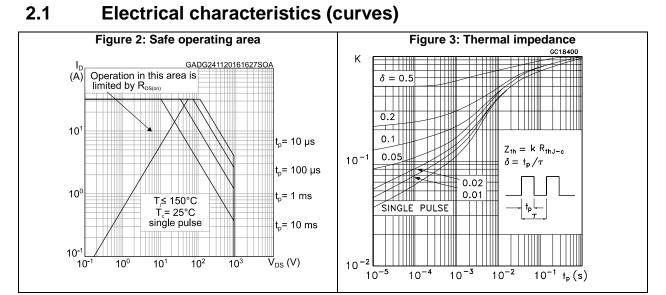
 $^{(2)}$ Pulsed: pulse duration = 300 µs, duty cycle 1.5%

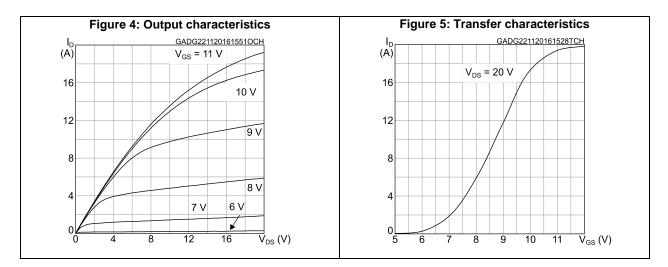
Table 9:	Gate-source	Zener	diode
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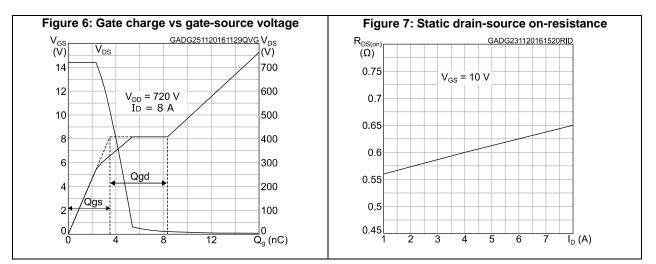
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
V (BR)GSO	Gate-source breakdown voltage	$I_{GS}=\pm 1mA$, $I_{D}=0A$	30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.







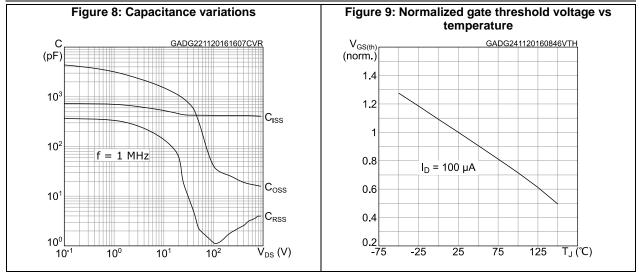


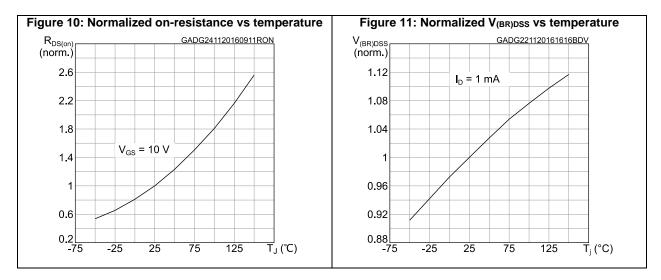
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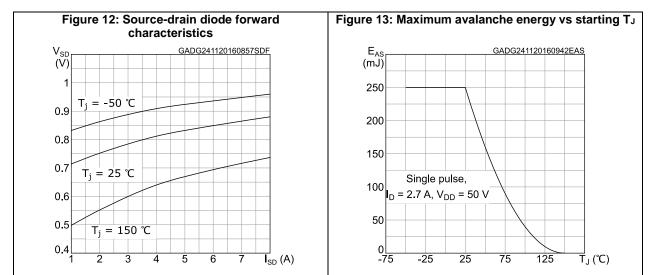


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Electrical characteristics



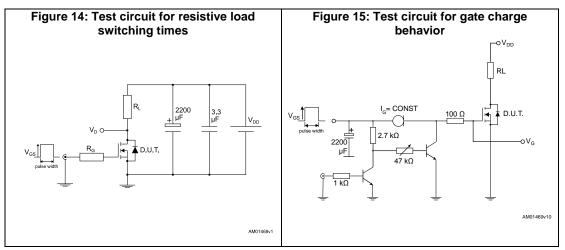


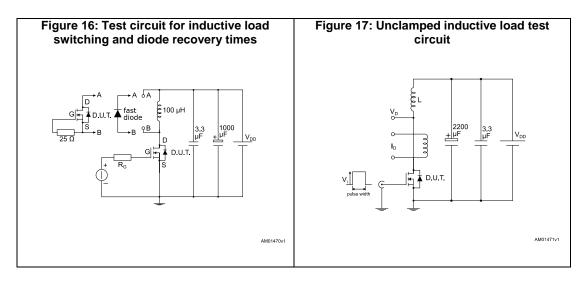


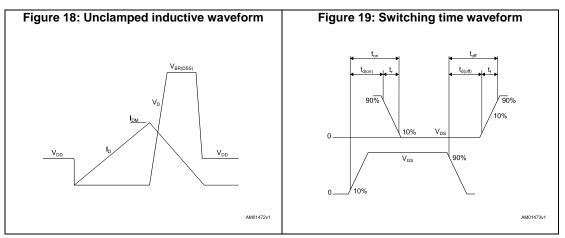
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3 Test circuits







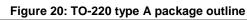


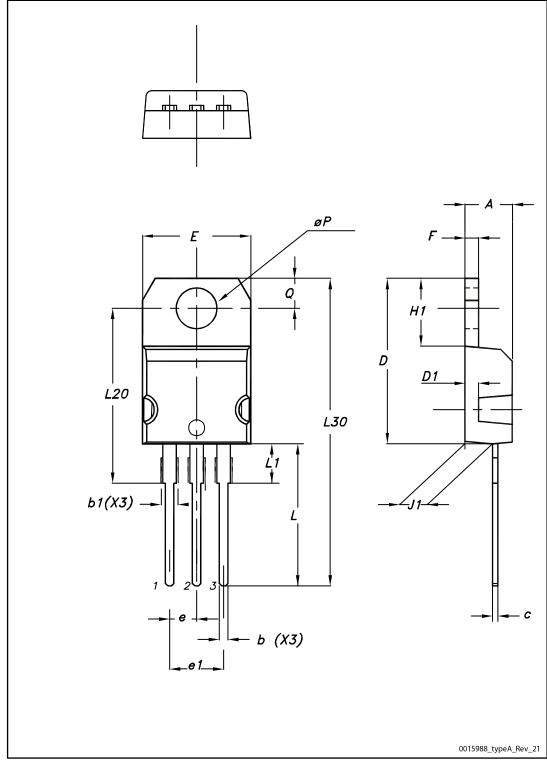
4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.











Package information

(5			Package information		
Table 10: TO-220 type A mechanical data					
Dim.	mm				
	Min.	Тур.	Max.		
A	4.40		4.60		
b	0.61		0.88		
b1	1.14		1.55		
С	0.48		0.70		
D	15.25		15.75		
D1		1.27			
E	10.00		10.40		
е	2.40		2.70		
e1	4.95		5.15		
F	1.23		1.32		
H1	6.20		6.60		
J1	2.40		2.72		
L	13.00		14.00		
L1	3.50		3.93		
L20		16.40			
L30		28.90			
øP	3.75		3.85		
Q	2.65		2.95		



Revision history 5

Table 11:	Document	revision	historv
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Date	Revision	Changes
28-Nov-2016	1	First release



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